

# **MOS Field Effect Power Transistors**

2SK2723

# SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

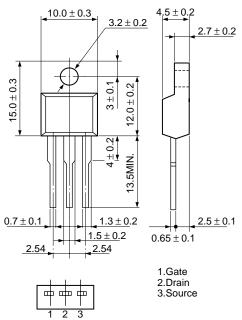
#### **DESCRIPTION**

This product is N-Channel MOS Field Effect Transistor designed for high current switching spplications.

#### **FEATURES**

- · Low On-Resistance
  - RDS (on) 1 =  $40m\Omega$  Max. (VGS = 10 V, ID = 13 A) RDS (on) 2 =  $60m\Omega$  Max. (VGS = 4 V, ID = 13 A)
- Low Ciss Ciss = 830 pF Typ.
- · Built-in G-S Protection Diode
- Isolated TO-220 Package

# PACKAGE DIMENSIONS (in millimeter)



MP-45F (ISOLATED TO-220)

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	VDSS	60	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	ID (DC)	±25	Α
Drain Current (pulse)*	ID (pulse)	±100	Α
Total Power Dissipation (T <sub>A</sub> = 25 °C)	Рт	2.0	W
Total Power Dissipation (Tc = 25 °C)	Рт	25	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
*PW $\leq$ 10 $\mu$ s, Duty Cycle $\leq$ 1%			

Gate Protection Diode Source

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this deveice acutally used, an additional protection circuit is externally required if voltage exceeding the rated voltage may be applied to this device.

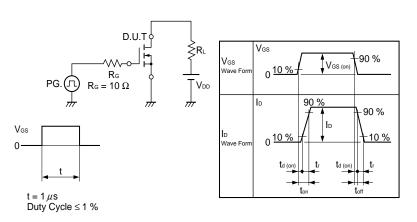
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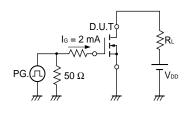
## ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source	RDS (on) 1	Vgs = 10 V, ID = 13 A		28	40	mΩ
On-state Resistance	RDS (on) 2	Vgs = 4 V, ID = 13 A		45	60	mΩ
Gate to Source Cutoff Voltage	VGS (off)	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.0	1.6	2.0	V
Forward Transfer Admittance	y fs	VDS = 10 V, ID = 13 A	8.0	18		S
Drain Leakage Current	IDSS	Vps = 60 V, Vgs = 0			10	μΑ
Gate to Source Leakage Current	Igss	Vgs = ±20 V, Vps = 0			±10	μΑ
Input Capacitance	Ciss	Vps = 10 V		830		pF
Output Capacitance	Coss	Vgs = 0		430		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		185		pF
Turn-On Delay Time	td (on)	ID = 13 A		21		ns
Rise Time	tr	VGS (on) = 10 V		185		ns
Turn-Off Delay Time	td (off)	VDD = 30 V		100		ns
Fall Time	tf	$R_G = 10 \Omega$		110		ns
Total Gate Charge	Q <sub>G</sub>	ID = 25 A		35		nC
Gate to Source Charge	Qgs	VDD = 48 V		2.8		nC
Gate to Drain Charge	Q <sub>GD</sub>	Vgs = 10 V		15		nC
Body Diode Forward Voltage	VF (S-D)	IF = 25 A, VGS = 0		1.0		V
Reverse Recovery Time	trr	IF = 25 A, VGS = 0		60		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		125		nC

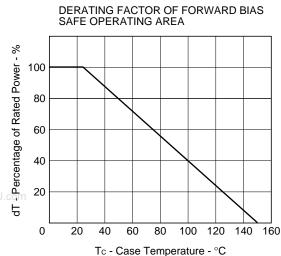
## **Test Circuit 1 Switching Time**



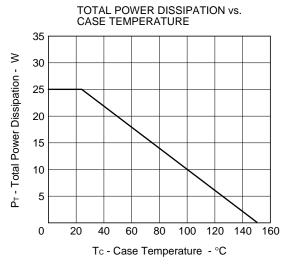
## Test Circuit 2 Gate Charge

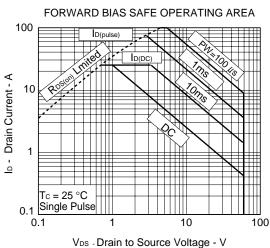




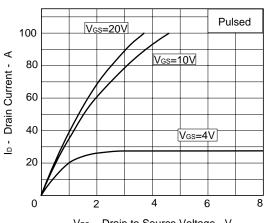


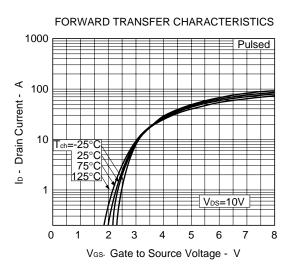








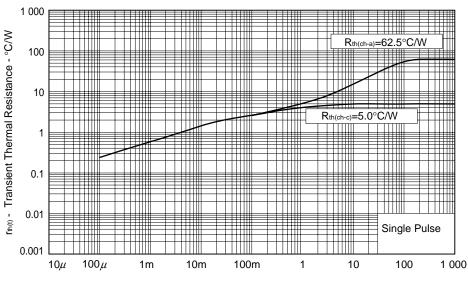




 $V_{\text{DS}}$  -  $\,$  Drain to Source Voltage - V

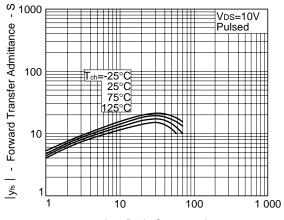


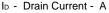
#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

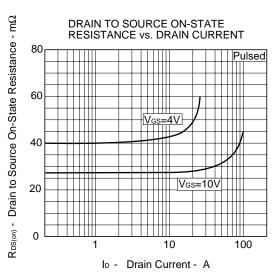


PW - Pulse Width - s

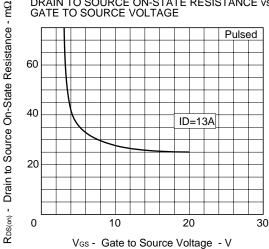




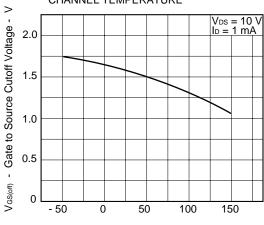




# DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

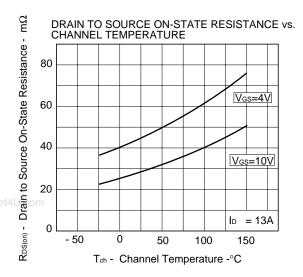


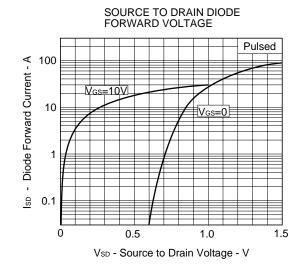
#### GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

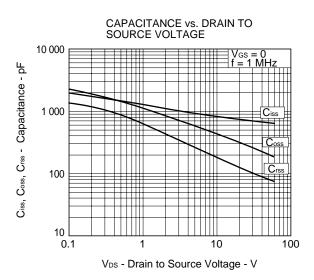


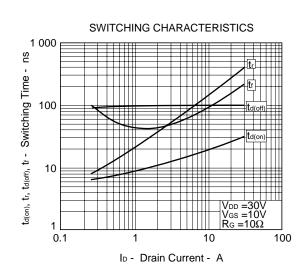
Tch - Channel Temperature - °C

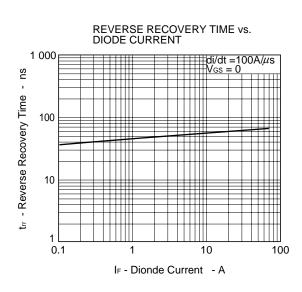


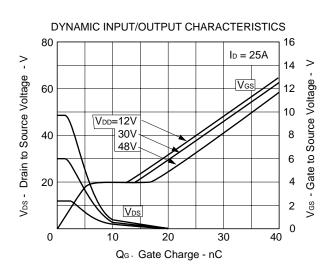














#### REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	C10535E
Semiconductor device package manual.	C10943X
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	X10679E
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

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Anti-radioactive design is not implemented in this product.

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